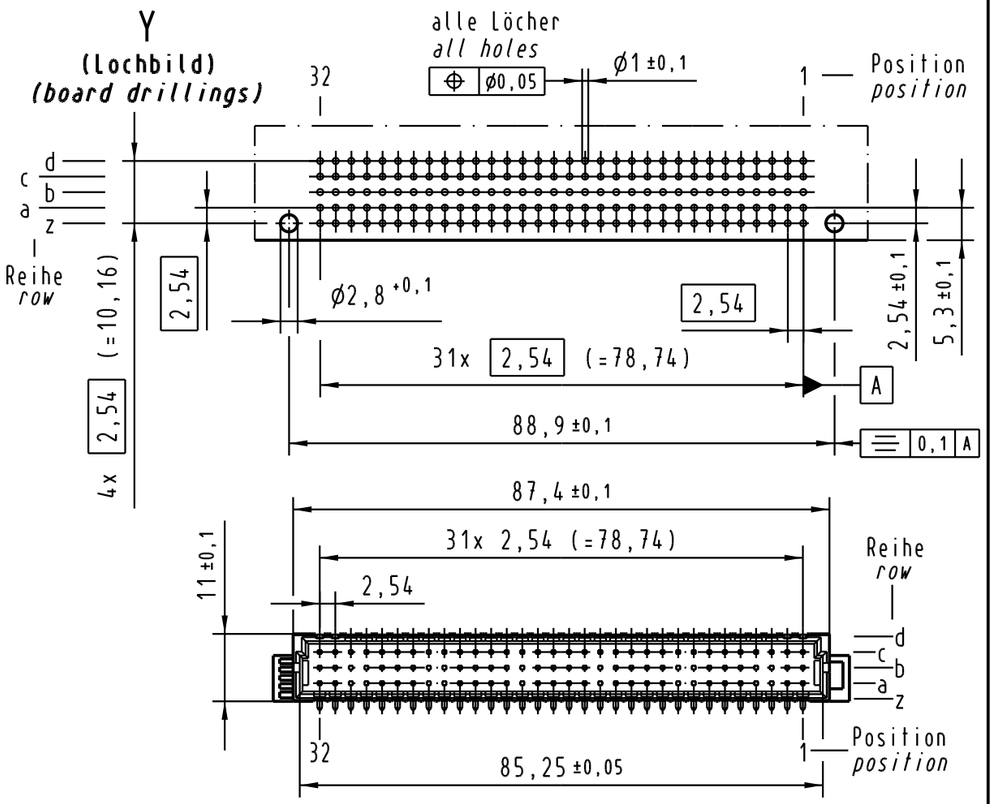
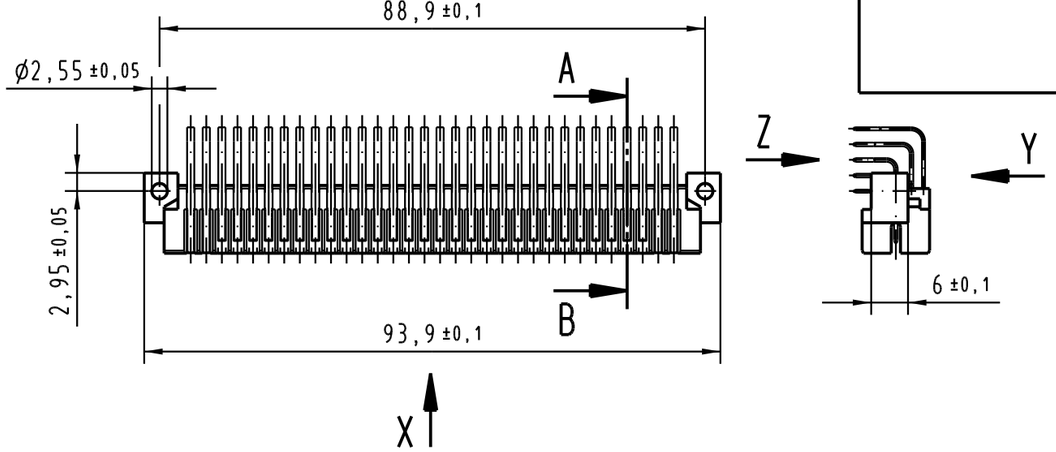
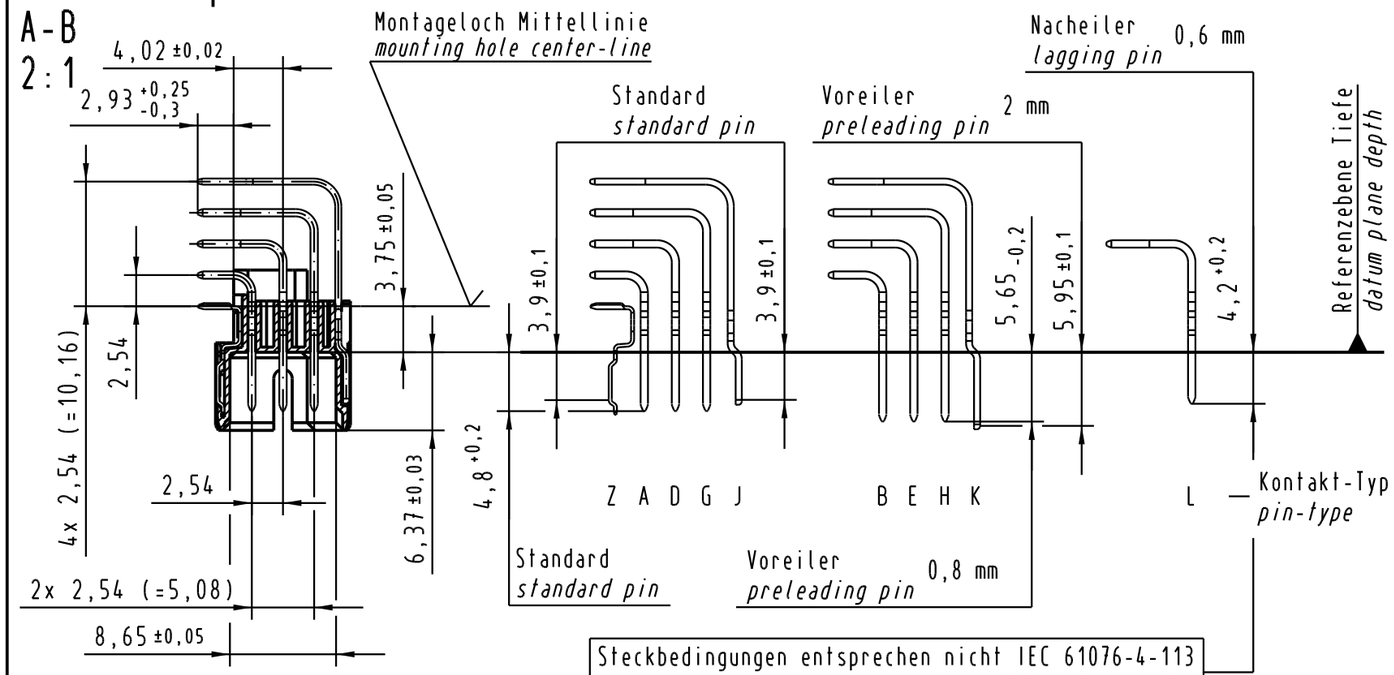
Alle Rechte vorbehalten/ All rights reserved

Y
(Lochbild)
(board drillings)



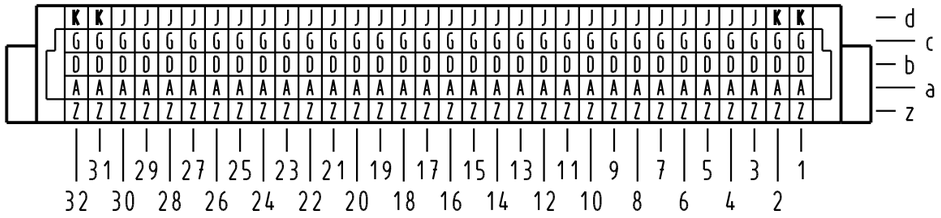


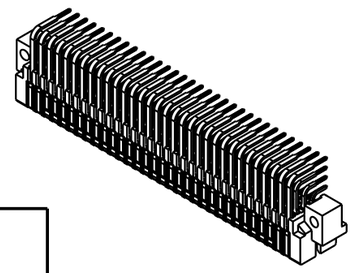
A-B
2 : 1



Steckbedingungen entsprechen nicht IEC 61076-4-113
mating conditions do not acc. to IEC 61076-4-113

X
Kontaktbelegung
contact loading

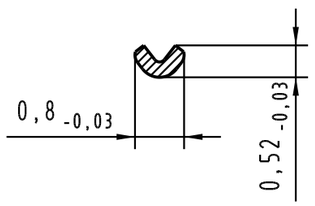




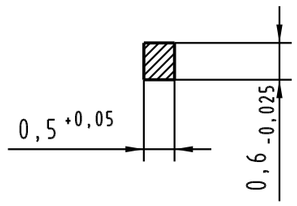
Z
10 : 1

Querschnitt der Lötanschlüsse:
cross-section of solder terminations:

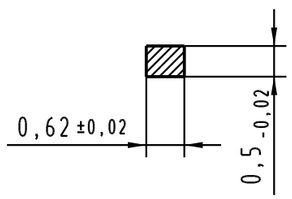
Reihe/*row* z: A = 0,21 - 0,25 mm²



Reihe/*row* a,b,c: A = 0,29 - 0,33 mm²



Reihe/*row* d: A = 0,29 - 0,32 mm²



02 01 160 2101	2	Au über/over Ni
02 01 160 1101	1	Au über/over Ni
Bestell-Nr. *part-no.*	Anforderungsstufe nach IEC *performance level acc.to IEC*	Kontaktoberfläche *contact plating*

Mod.	Dat.	Name
32687	26.04.05	Hage.
32460	25.01.05	Leh.
31412	08.04.03	Hage.
30920	09.04.02	Rie.
30792	23.01.02	Rie.
29408	28.03.01	Lk.

All Dimensions in mm
Original Size DIN A 3

Techn. Character.
IEC 61076-4-113

	Dat.	Name
Detail.	09.10.96	Rie.
Insp.	09.10.96	Pa.
Stand.		

Maßstab/*Scale*
1 : 1
(2 : 1)
(10 : 1)

Nicht tolerierte Maße/*Free size tolerances*
IEC 61076-4-113

har-bus 64 male connector

Einlöt 160 pol. SMC (Hochtemperatur)
solder 160 pol. SMC (high temperature)

HARTING Electronics GmbH & Co. KG
D-32339 ESPELKAMP

TB 02 01 160 x101

Sub.

Blatt/*page* /